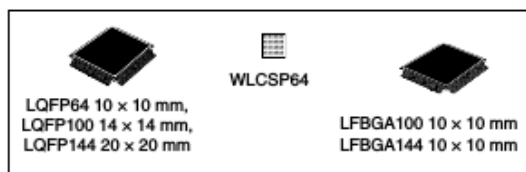


High-density performance line Arm[®]-based 32-bit MCU with 256 to 512KB Flash, USB, CAN, 11 timers, 3 ADCs, 13 communication interfaces

Datasheet –production data

Features

- Core: Arm[®] 32-bit Cortex[®]-M3 CPU
 - 72 MHz maximum frequency, 1.25 DMIPS/MHz (Dhrystone 2.1) performance at 0 wait state memory access
 - Single-cycle multiplication and hardware division
- Memories
 - 256 to 512 Kbytes of Flash memory
 - up to 64 Kbytes of SRAM
 - Flexible static memory controller with 4 Chip Select. Supports Compact Flash, SRAM, PSRAM, NOR and NAND memories
 - LCD parallel interface, 8080/6800 modes
- Clock, reset and supply management
 - 2.0 to 3.6 V application supply and I/Os
 - POR, PDR, and programmable voltage detector (PVD)
 - 4-to-16 MHz crystal oscillator
 - Internal 8 MHz factory-trimmed RC
 - Internal 40 kHz RC with calibration
 - 32 kHz oscillator for RTC with calibration
- Low power
 - Sleep, Stop and Standby modes
 - V_{BAT} supply for RTC and backup registers
- 3 × 12-bit, 1 μs A/D converters (up to 21 channels)
 - Conversion range: 0 to 3.6 V
 - Triple-sample and hold capability
 - Temperature sensor
- 2 × 12-bit D/A converters
- DMA: 12-channel DMA controller
 - Supported peripherals: timers, ADCs, DAC, SDIO, I²Ss, SPIs, I²Cs and USARTs
- Debug mode
 - Serial wire debug (SWD) & JTAG interfaces
 - Cortex[®]-M3 Embedded Trace Macrocell™
- Up to 112 fast I/O ports
 - 51/80/112 I/Os, all mappable on 16 external interrupt vectors and almost all 5 V-tolerant



- Up to 11 timers
 - Up to four 16-bit timers, each with up to 4 IC/OC/PWM or pulse counter and quadrature (incremental) encoder input
 - 2 × 16-bit motor control PWM timers with dead-time generation and emergency stop
 - 2 × watchdog timers (Independent and Window)
 - SysTick timer: a 24-bit downcounter
 - 2 × 16-bit basic timers to drive the DAC
- Up to 13 communication interfaces
 - Up to 2 × I²C interfaces (SMBus/PMBus)
 - Up to 5 USARTs (ISO 7816 interface, LIN, IrDA capability, modem control)
 - Up to 3 SPIs (18 Mbit/s), 2 with I²S interface multiplexed
 - CAN interface (2.0B Active)
 - USB 2.0 full speed interface
 - SDIO interface
- CRC calculation unit, 96-bit unique ID
- ECOPACK[®] packages

Table 1. Device summary

Reference	Part number
STM32F103xC	STM32F103RC STM32F103VC STM32F103ZC
STM32F103xD	STM32F103RD STM32F103VD STM32F103ZD
STM32F103xE	STM32F103RE STM32F103ZE STM32F103VE

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